

PRODUCTION DATA SHEET

DESCRIPTION

The Microsemi LX1918 is a step Schottky diode external voltage. The input supply voltage no load. range is from 2.7V to 5.5V with a maximum output current of 1.8A.

PWM with optional PFM under light limiting and thermal shut down. loads. The LX1918 can switch with a 1MHz free running internal oscillator MLP package (fully RoHS compliant). or be synchronized with an external oscillator ranging from 500KHz to 1.25MHz; the high frequency allows for small size and low cost external components. The LX1918 output voltage is programmable with two resistors and can be tightly regulated down to 0.6V.

The LX1918 MODE feature can regulator with a either maximize efficiency or reduce synchronous rectifier. All MOSFET EMI depending on the needs of the switches and compensation com- application. High efficiency (MODE = ponents are built in. The synchronous GND) is obtained by allowing the rectification eliminates the need of an LX1918 to enter a PFM mode with and discontinuous inductor current. Low maximizes efficiency (>95%) for a EMI (MODE=VCC) is obtained by high step-down ratio and a low output only operating in PWM mode even at

The LX1918 features include soft start, cycle-by-cycle switch current The LX1918 is a current mode limit, hiccup short circuit current

The LX1918 comes in small 8 pin

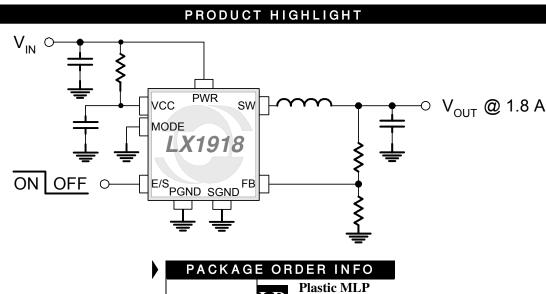
KEY FEATURES

- Input range voltage 2.7 to 5.5V
- Maximum output current, 1.8A
- Internal or External Synchronization
- Output Voltage from V_{IN} to 0.6V
- PFM or PWM mode under light
- EMI support with force PWM mode
- Efficiency up to 95%
- No external Schottky diode
- Thermal shutdown
- Cycle by cycle switch current limit
- **UVLO**
- Short circuit protection
- 8 pin MLP

APPLICATIONS

- Lower power embedded applications
- WLAN power system
- Portable design with single cell Lion or 3 cells NiMH/NiCd
- Low power portable storage application

IMPORTANT: For the most current data, consult *MICROSEMI*'s website: http://www.microsemi.com



Note: Available in Tape & Reel. Append the letters "TR" to the part number.(i.e. LX1918CLD-TR)

8-Pin 3x3mm RoHS Compliant / Pb-free

LX1918CLD

 T_A (°C)

-40 to 85



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ABSOLUTE MAXIMUM RATINGS

Supply Input Voltage (PWR, VCC)Supply Input Transient Voltage (PWR, VCC)	
Input Voltage (E/S, FB,MODE)	
Maximum Switch Voltage (SW)	0.3V to $(V_{PWR} + 0.3V)$
SW Peak Current (Internally Limited)	3.6A
Operating Ambient Temperature Range	40°C to +85°C
Operating Junction Temperature Range	40°C to +125°C
Maximum Operating Junction Temperature	150°C
Storage Temperature Range	65°C to 150°C
Peak Package Solder Reflow Temp. (40 second max. e	exposure) 260°C (+0, -5)

Note: Exceeding these ratings could cause damage to the device. All voltages are with respect to Ground. Currents are positive into, negative out of specified terminal.

THERMAL DATA

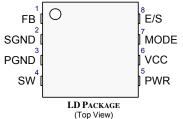
Plastic MLP 3mm X 3mm 8-Pin

THERMAL RESISTANCE-JUNCTION TO AMBIENT, θ_{JA} 35 – 50°C/W

Junction Temperature Calculation: $T_J = T_A + (P_D \times \theta_{JA})$.

The θ_{JA} numbers are guidelines for the thermal performance of the device/pc-board system. All of the above assume no ambient airflow. The variation in overall thermal resistance, Θ_{JA} , is directly affected by heatsink area available on the PCB.

PACKAGE PIN OUT





LD PACKAGE MARKINGS
"xxxx" Denote Date Code and Lot Identification

RoHS / Pb-free 100% Matte Tin Lead Finish

	FUNCTIONAL PIN DESCRIPTION			
PIN	Name	Description		
1	FB	Feedback Pin - This pin is regulated to the internal reference voltage.		
2	SGND	Signal Ground – Low current signal ground reference for IC; also attaches to bottom pad. Connect to common ground reference.		
3	PGND	Ground – High current ground; connects to common ground reference.		
4	SW	MOSFET Switch (Drain) Connects for inductor.		
5	PWR	Power Input – Connect a decoupled voltage source between 2.7V and 5.5V.		
6	VCC	Reference power supply for IC.		
7	MODE	Light Load Mode Select - Ground for Highest efficiency mode or pull high for Lowest EMI mode during light load operation.		
8	E/S	Enable and External Synchronization – Pull high to enable operation with internal oscillator. Apply an external oscillator signal to synchronize the PWM switch frequency. Apply logic low to cause IC to enter Shutdown mode.		



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ELECTRICAL CHARACTERISTICS

Unless otherwise specified, the following specifications apply over the operating ambient temperature² -40°C \leq T_A \leq 85°C³ except where otherwise noted and the following test conditions: V_{IN} = 3.7V; VE/S = 3.7V; VMODE = GND

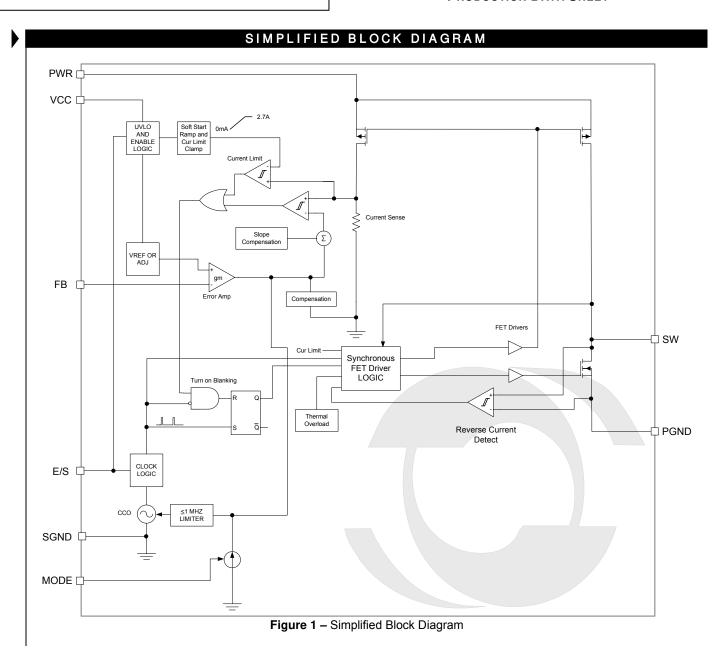
Parameter	Symbol	Symbol Test Conditions		LX1918		
Parameter	Syllibol	rest Conditions	Min	Тур	Max	Units
ENTIRE REGULATOR						
Input Voltage ³	V_{PWR}, V_{CC}		2.7		6.0	V
Efficiency ¹	η	$V_{OUT} = 1.8V, I_{OUT} = 200mA$		92		%
Quiescent Current						
 Active 	Icc	$V_{E/S} = 3.6V$; $V_{FB} = 1.0V$; $T = 25$ °C		350	500	μΑ
Shutdown		$V_{E/S} = GND$		0.5	1.0	
Line Regulation ¹		$V_{IN} = 2.7 \text{ to } 5.5 \text{V}$		1		%
Load Regulation ¹		I _{OUT} = 10mA to 1.5A		1		%
Feedback Voltage	V_{FB}		0.588	0.600	0.612	V
FB Input Current	I_{FB}	$V_{FB} = 0.5V \text{ to } 0.7V$	-50		50	nA
Internal Oscillator frequency	Fosc	$V_{E/S} = 3.6V$; $V_{MODE} = 3.6V$	0.75	1.00	1.25	MHz
E/S Pin Bias Current		$V_{E/S} = GND$		0.1	1.0	μΑ
E/S Logic High Input	V _{E/S(HI)}		1.6			V
E/S Logic Low Input	V _{E/S(LO)}				0.4	V
SYNC Capture Range		V _{MODE} = 3.6V	500		1250	kHz
SYNC Minimum Pulse Width		High or Low; V _{MODE} = 3.6V	100			ns
MODE Bias Current		$V_{E/S} = GND: V_{MODE} = V_{IN}$		1.0	2.0	μΑ
MODE Logic High	V _{MODE(HI)}		0.9 x V _{IN}			
MODE Logic Low					0.1 x	V
MODE LOGIC LOW	V _{MODE(LO)}				V_{IN}	
SW Pin Current Limit		Peak Current	2.0	2.7	3.6	Α
Thermal Shutdown Threshold ¹			130	140	150	°C
Under Voltage Lockout	V_{UVLO}				2.7	V

Notes

- 1. Guaranteed by design, but not tested.
- 2. Low duty cycle pulse testing techniques are used which maintains junction and case temperatures equal to the ambient temperature.
- 3. Functionality over the -40°C to +85°C operating temperature range is assured by design, characterization, and correlation.



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APPLICATION CIRCUITS

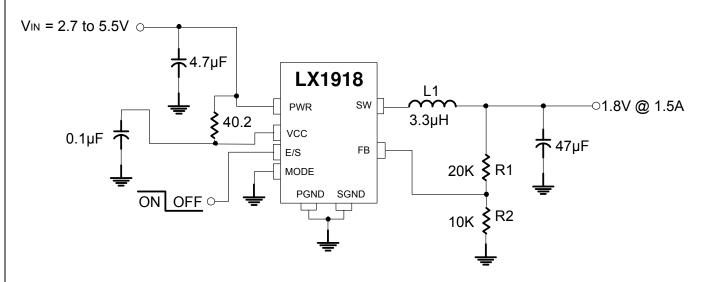


Figure 2 – Typical Application: Highest Light Load Efficiency Mode During Light Load With Internal 1MHz PWM Frequency

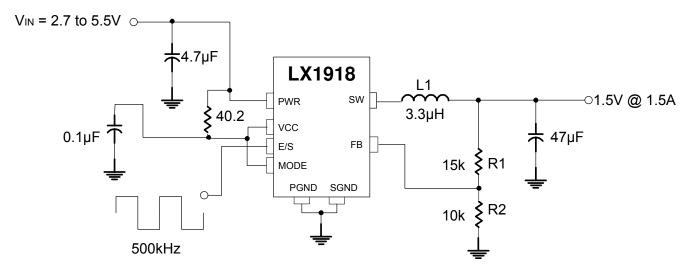


Figure 3 – Typical Application: PWM Low EMI Mode Operation During Light Load With External 500kHz Synchronization



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THEORY OF OPERATION

LX1918 is synchronous step down converter with input voltage range from 2.7V to 5.5V; and outputs ranging from 0.6V to 80% of $V_{\rm IN}$. The LX1918 can deliver a maximum output current up to 1.8A. The LX1918 has two selectable operating modes for light loads: high efficiency PFM (MODE=GND) or low noise forced PWM (MODE=VCC). Under heavy load, LX1918 always operates in PWM mode and switches at fixed internal 1MHz frequency or can be synchronized with an external oscillator clock with a frequency ranging from 500 KHz to 1.25MHz.

Switching frequency

The E/S pin has dual function. If E/S pin pulls HIGH, the 1MHz internal oscillator is enabled. If E/S pin is held LOW, the LX1918 will enter Shut Down mode. Designers can apply an external oscillator signal, 500 KHz to 1.25MHz, to E/S pin to synchronize the switching frequency to a system clock. When applying external oscillator signal, the MODE pin must pull up to VCC activating the forced PWM mode.

High Efficiency Operation: PFM, PWM, and EMI force PWM modes

The LX1918 has two selectable operating modes for light loads: high efficiency PFM (MODE=GND) or low noise forced PWM(MODE=VCC). Only one mode can be active at any time.

Under light load operation, defined as I_{OUT} <300mA, if the MODE pin = VCC, the continuous inductor current mode is selected. This forces fixed frequency PWM and synchronous rectification regardless of loading. The inductor ripple current and duty cycle remain the same, the synchronous rectifier allows the inductor current to go positive or negative preventing system from going into discontinuous conduction and preventing possible EMI associated with inductor ringing.

If MODE pin is LOW, discontinuous current is selected. The PWM frequency slows down as the load decreases and this reduces switching losses. In this mode, the NMOS switch turns off to prevent negative current flow and allows the inductor current to reduce to zero (which is known as discontinuous conduction mode).

Comparing the efficiency of the two modes of operation under light loading, when $I_{OUT} = 25 \text{mA}$, LX1918 efficiency is 80% (MODE=GND) and 68% (MODE=VCC).

Under heavy load (I_{OUT}>500mA), LX1918 always operates in PWM mode, with an efficiency up to 92%.

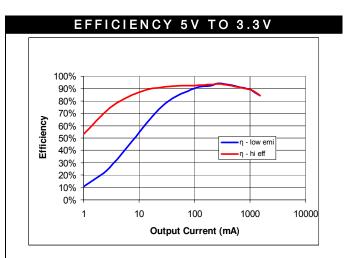
Protection:

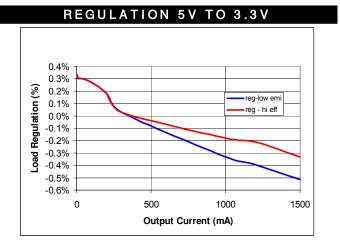
LX1918 provides thermal shutdown, UVLO, and current limit protection:

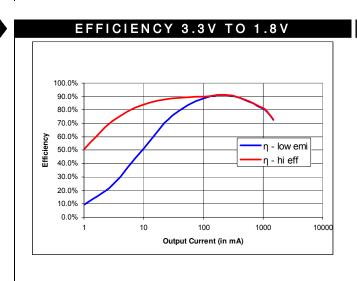
- Thermal shutdown: if the die temperature reaches 150°C
- UVLO: an under voltage lock out, LX1918 will shut down when $V_{IN} < 2.7V$.
- Current limiting protection:
 - Switch current limit: The PMOS switch is limited to a peak current of 2.7A. The PMOS "switch on" cycle is terminated when the switch current limit is reached.
 - Soft start: Upon start up, the switch current is limited to a gradual rise of 0 to 2.7A in 100us. The synchronous rectifier remains off during soft start preventing reverse load
 - Hiccup mode: If the PMOS switch is current limited when it attempts to turns on (indicating an output short circuit), the converter will enter a partial soft start cycle mode to prevent a runaway output current.

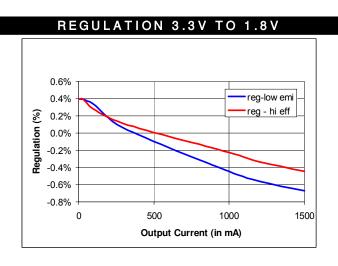


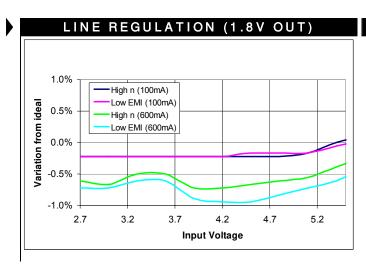
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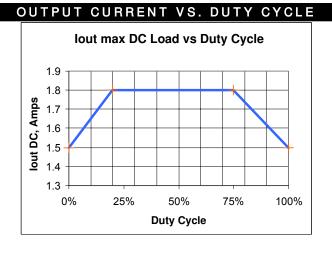










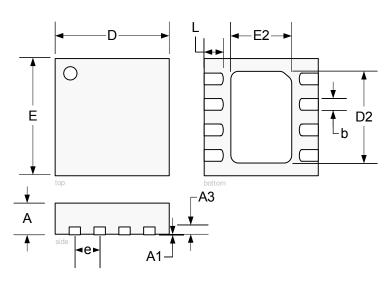




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PACKAGE DIMENSIONS

8 Pin Plastic MLP Dual Exposed Pad



	MILLIN	METERS	INCHES		
Dim	MIN	MAX	MIN	MAX	
Α	0.80	1.00	0.0315	0.0394	
A1	0	0.05	0	0.0019	
A3	0.20 REF		0.0079 REF		
b	0.25	0.30	0.010	0.0118	
D	3.00	BSC	0.1181 BSC		
D2	1.60	2.50	0.0630	0.0984	
е	0.65 BSC		0.0260 BSC		
E	3.00	BSC	0.1181 BSC		
E2	1.35	1.75	0.0531	0.0689	
L	0.30	0.50	0.0071	0.0197	

Note:

 Dimensions do not include mold flash or protrusions; these shall not exceed 0.155mm(.006") on any side. Lead dimension shall not include solder coverage.



LX1918

1.8A Step-Down Synchronous Converter

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NOTES

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